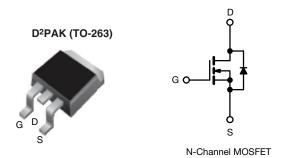
Vishay Siliconix

COMPLIANT

HALOGEN

**FREE** 

# **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.38		
Q <sub>g</sub> max. (nC)	88			
Q <sub>gs</sub> (nC)	9			
Q <sub>gd</sub> (nC)	16			
Configuration	Single			

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	D <sup>2</sup> PAK (TO-263)
Lead (Pb)-free and halogen-free	SiHB11N80E-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_{\text{C}}$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	800		
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	,	12		
		T <sub>C</sub> = 100 °C	ID	8	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	32		
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	226	mJ	
Maximum power dissipation			$P_{D}$	179	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		-11.//-14	70	) //	
Reverse diode dV/dt d	•		dV/dt	4.3	- V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s			300	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 4.0 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C



# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	$R_{thJA}$	-	62	°C/W	
Maximum junction-to-case (drain)	$R_{thJC}$	-	0.7	C/VV	

PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT		
Static					•	•			
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		800	-	-	V		
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	1.1	-	V/°C		
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	4	V		
Cata aguras laglaga	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}$		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage		,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ		
Zava sata valtasa duain avuvant		V <sub>DS</sub> =	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V V <sub>DS</sub> = 640 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	1	μА		
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V			-	10			
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 5.5 A	-	0.38	0.44	Ω		
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 5.5 A		-	4.5	-	S		
Dynamic									
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		-	1670	-	pF		
Output capacitance	C <sub>oss</sub>			-	68	-			
Reverse transfer capacitance	C <sub>rss</sub>			-	9	-			
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	43	-			
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	212	-			
Total gate charge	Qg			-	44	88			
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 5.5 \text{ A}, V_{DS} = 480 \text{ V}$		9	-	nC		
Gate-drain charge	Q <sub>gd</sub>				16	-			
Turn-on delay time	t <sub>d(on)</sub>			-	18	36			
Rise time	t <sub>r</sub>	$V_{DD} = 480 \text{ V}, I_D = 5.5 \text{ A},$		-	15	30	ns		
Turn-off delay time	t <sub>d(off)</sub>		$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		55	110			
Fall time	t <sub>f</sub>	1		-	18	36			
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.4	0.9	1.8	Ω		
Drain-Source Body Diode Characteristic	s								
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12			
Pulsed diode forward current	I <sub>SM</sub>			-	-	32	A		
Diode forward voltage	V <sub>SD</sub>	$T_J = 25  ^{\circ}\text{C},  I_S = 5.5  \text{A},  V_{GS} = 0  \text{V}$		-	-	1.2	V		
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 5.5 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s}, V_R = 25 \text{ V}$		-	345	690	ns		
Reverse recovery charge	Q <sub>rr</sub>			-	4.2	8.4	μC		
Reverse recovery current	I <sub>RRM</sub>			_	21	-	A		

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

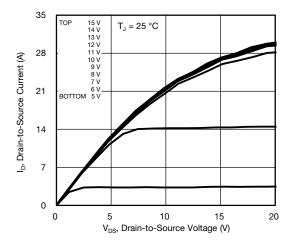


Fig. 1 - Typical Output Characteristics

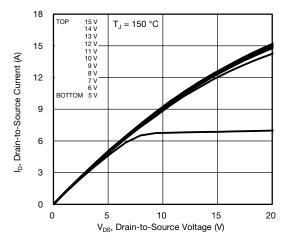


Fig. 2 - Typical Output Characteristics

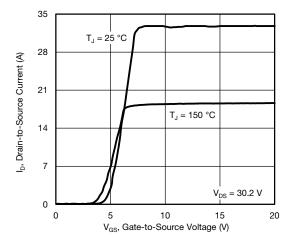


Fig. 3 - Typical Transfer Characteristics

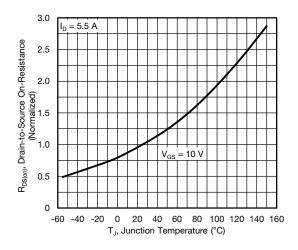


Fig. 4 - Normalized On-Resistance vs. Temperature

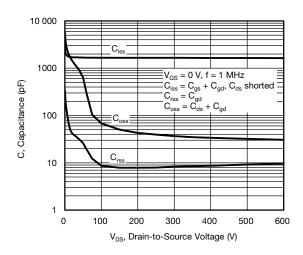


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

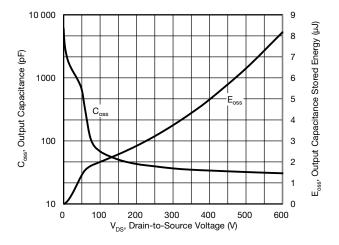


Fig. 6 -  $C_{oss}$  and  $E_{oss}\, vs.\, V_{DS}$ 



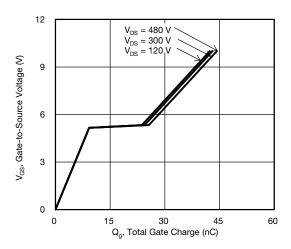


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

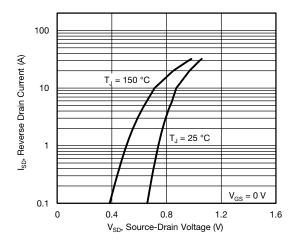


Fig. 8 - Typical Source-Drain Diode Forward Voltage

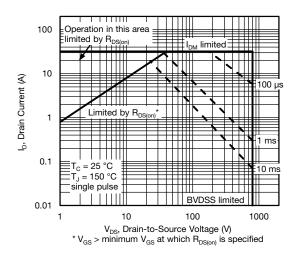


Fig. 9 - Maximum Safe Operating Area

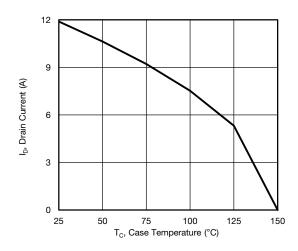


Fig. 10 - Maximum Drain Current vs. Case Temperature

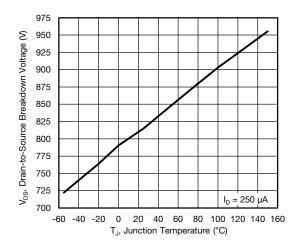


Fig. 11 - Temperature vs. Drain-to-Source Voltage



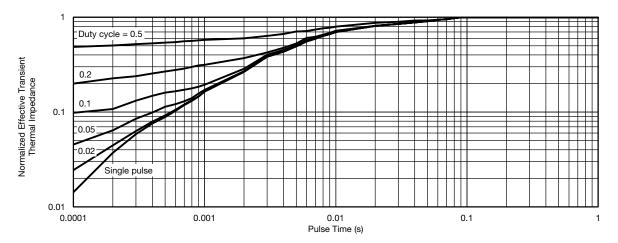


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

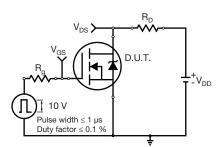


Fig. 13 - Switching Time Test Circuit

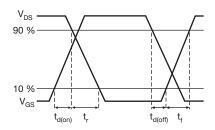


Fig. 14 - Switching Time Waveforms

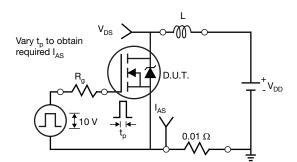


Fig. 15 - Unclamped Inductive Test Circuit

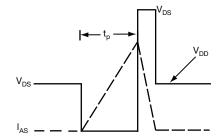


Fig. 16 - Unclamped Inductive Waveforms

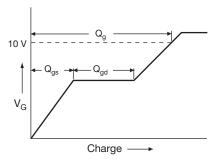


Fig. 17 - Basic Gate Charge Waveform

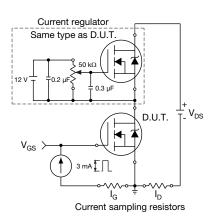
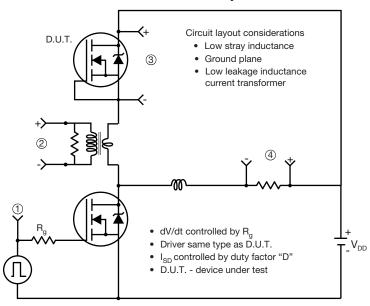


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



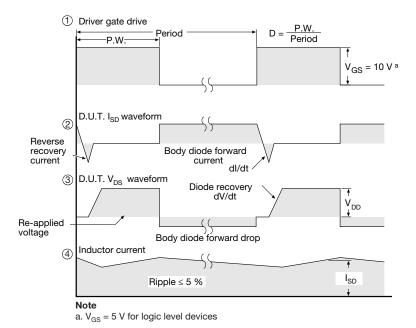


Fig. 19 - For N-Channel

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